



LEXAN™ Resin HPX4

Americas: COMMERCIAL

Medium flow specialty polycarbonate - improved processability & autoclavability. For medical devices and pharmaceutical applications. Healthcare management of change, biocompatible (ISO10993 or USP Class VI). EtO and steam sterilizable.

TYPICAL PROPERTIES ¹	TYPICAL VALUE	Unit	Standard
MECHANICAL			
Tensile Stress, yld, Type I, 50 mm/min	590	kgf/cm ²	ASTM D 638
Tensile Stress, brk, Type I, 50 mm/min	650	kgf/cm ²	ASTM D 638
Tensile Strain, yld, Type I, 50 mm/min	5.8	%	ASTM D 638
Tensile Strain, brk, Type I, 50 mm/min	131.4	%	ASTM D 638
Tensile Modulus, 50 mm/min	22500	kgf/cm ²	ASTM D 638
Flexural Stress, yld, 1.3 mm/min, 50 mm span	960	kgf/cm ²	ASTM D 790
Flexural Modulus, 1.3 mm/min, 50 mm span	22500	kgf/cm ²	ASTM D 790
Hardness, Rockwell L	89	-	ASTM D 785
Tensile Stress, yield, 50 mm/min	57	MPa	ISO 527
Tensile Stress, break, 50 mm/min	61	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	5.5	%	ISO 527
Tensile Strain, break, 50 mm/min	124.9	%	ISO 527
Tensile Modulus, 1 mm/min	2350	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	90	MPa	ISO 178
Flexural Modulus, 2 mm/min	2150	MPa	ISO 178
IMPACT			
Izod Impact, notched, 23°C	90	cm-kgf/cm	ASTM D 256
Izod Impact, notched, -30°C	81	cm-kgf/cm	ASTM D 256
Instrumented Impact Total Energy, 23°C	840	cm-kgf	ASTM D 3763
Instrumented Impact Total Energy, -30°C	866	cm-kgf	ASTM D 3763
Izod Impact, unnotched 80*10*3 +23°C	NB	kJ/m ²	ISO 180/1U
Izod Impact, unnotched 80*10*3 -30°C	NB	kJ/m ²	ISO 180/1U



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TYPICAL PROPERTIES ¹	TYPICAL VALUE	Unit	Standard
IMPACT			
Izod Impact, notched 80*10*3 +23°C	65	kJ/m ²	ISO 180/1A
Izod Impact, notched 80*10*3 -30°C	55	kJ/m ²	ISO 180/1A
Charpy 23°C, V-notch Edgew 80*10*3 sp=62mm	65	kJ/m ²	ISO 179/1eA
Charpy -30°C, V-notch Edgew 80*10*3 sp=62mm	55	kJ/m ²	ISO 179/1eA
Charpy 23°C, Unnotch Edgew 80*10*3 sp=62mm	NB	kJ/m ²	ISO 179/1eU
Charpy -30°C, Unnotch Edgew 80*10*3 sp=62mm	NB	kJ/m ²	ISO 179/1eU
THERMAL			
Vicat Softening Temp, Rate A/50	141	°C	ASTM D 1525
HDT, 1.82 MPa, 3.2mm, unannealed	124	°C	ASTM D 648
CTE, -40°C to 95°C, flow	7.15E-05	1/°C	ASTM E 831
CTE, -40°C to 95°C, xflow	7.93E-05	1/°C	ASTM E 831
CTE, 23°C to 80°C, flow	7.15E-05	1/°C	ISO 11359-2
CTE, 23°C to 80°C, xflow	7.93E-05	1/°C	ISO 11359-2
Ball Pressure Test, 125°C +/- 2°C	pass	-	IEC 60695-10-2
Vicat Softening Temp, Rate B/50	141	°C	ISO 306
Vicat Softening Temp, Rate B/120	142	°C	ISO 306
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	118	°C	ISO 75/Af
Relative Temp Index, Elec	130	°C	UL 746B
Relative Temp Index, Mech w/o impact	130	°C	UL 746B
PHYSICAL			
Specific Gravity	1.19	-	ASTM D 792
Mold Shrinkage, flow, 3.2 mm (5)	0.4 - 0.8	%	SABIC Method
Mold Shrinkage, xflow, 3.2 mm (5)	0.4 - 0.8	%	SABIC Method
Melt Flow Rate, 300°C/1.2 kgf	10	g/10 min	ASTM D 1238
Density	1.19	g/cm ³	ISO 1183



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TYPICAL PROPERTIES ¹	TYPICAL VALUE	Unit	Standard
PHYSICAL			
Water Absorption, (23°C/sat)	0.12	%	ISO 62
Moisture Absorption (23°C / 50% RH)	0.09	%	ISO 62
Melt Volume Rate, MVR at 300°C/1.2 kg	9	cm ³ /10 min	ISO 1133
OPTICAL			
Light Transmission, 2.54 mm	82	%	ASTM D 1003
Haze, 2.54 mm	3	%	ASTM D 1003
ELECTRICAL			
Volume Resistivity	>1.E+15	Ohm-cm	ASTM D 257
Surface Resistivity	>1.E+15	Ohm	ASTM D 257
FLAME CHARACTERISTICS			
UL Recognized, 94V-2 Flame Class Rating (3)	2.5	mm	UL 94
Glow Wire Flammability Index 960°C, passes at	3	mm	IEC 60695-2-12
Glow Wire Ignitability Temperature, 0.8 mm	825	°C	IEC 60695-2-13
Glow Wire Ignitability Temperature, 3.0 mm	825	°C	IEC 60695-2-13



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PROCESSING PARAMETERS	TYPICAL VALUE	Unit
Injection Molding		
Drying Temperature	120	°C
Drying Time	3 - 4	hrs
Drying Time (Cumulative)	48	hrs
Maximum Moisture Content	0.02	%
Melt Temperature	295 - 315	°C
Nozzle Temperature	290 - 310	°C
Front - Zone 3 Temperature	295 - 315	°C
Middle - Zone 2 Temperature	280 - 305	°C
Rear - Zone 1 Temperature	270 - 295	°C
Mold Temperature	70 - 95	°C
Back Pressure	0.3 - 0.7	MPa
Screw Speed	40 - 70	rpm
Shot to Cylinder Size	40 - 60	%
Vent Depth	0.025 - 0.076	mm



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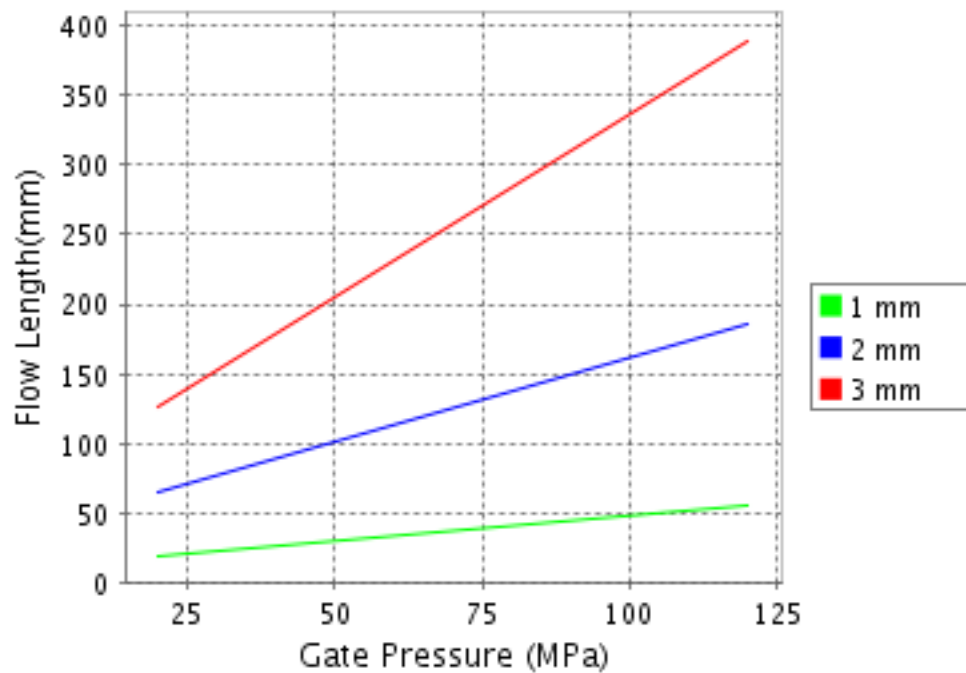
CALCULATED FLOW LENGTH INDICATION

Moldflow® Radial Flow Analysis

LEXAN® HPX4

Melt Temperature : 305°C

Mold Temperature : 85°C



Note: Technical support is recommended if Gate Pressure is greater than 80 MPa. Contact your local representative.

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